

# GB2X50MPS17-227 1700V 100A SiC Schottky MPS™ Diode



## Silicon Carbide Schottky Diode

$V_{RRM}$	=	1700 V
$I_F (T_C = 100^\circ\text{C})$	=	182 A *
$Q_C$	=	1076 nC *

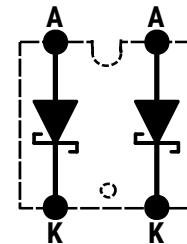
### Features

- Low  $V_F$  for High Temperature Operation
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit  $Q_C/I_F$
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of  $V_F$
- Low  $V_F$  for High Temperature Operation

### Package



SOT-227



### Advantages

- Improved System Efficiency
- High System Reliability
- Optimal Price Performance
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Improved System Efficiency

### Applications

- EV Fast Chargers
- Solar Inverters
- Wind Energy Converters
- Train Auxiliary Power Supplies
- High Frequency Rectifiers
- Switched Mode Power Supplies
- Motor Drives
- Pulsed Power

### Absolute Maximum Ratings (At $T_C = 25^\circ\text{C}$ Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage (Per Leg)	$V_{RRM}$		1700	V	
Continuous Forward Current (Per Leg / Per Device)	$I_F$	$T_C = 75^\circ\text{C}, D = 1$	107 / 214	A	Fig. 4
		$T_C = 100^\circ\text{C}, D = 1$	91 / 182		
		$T_C = 148^\circ\text{C}, D = 1$	50 / 100		
Non-Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	540	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	432		
Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	$I_{F,RM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	324	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	227		
Non-Repetitive Peak Forward Surge Current (Per Leg)	$I_{F,MAX}$	$T_C = 25^\circ\text{C}, t_P = 10 \mu\text{s}$	2700	A	
$i^2t$ Value (Per Leg)	$\int i^2 dt$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	1458	$\text{A}^2\text{s}$	
Non-Repetitive Avalanche Energy (Per Leg)	$E_{AS}$	$L = 1.0 \text{ mH}, I_{AS} = 50 \text{ A}$	1301	mJ	
Diode Ruggedness (Per Leg)	$dV/dt$	$V_R = 0 \sim 1360 \text{ V}$	200	V/ns	
Power Dissipation (Per Leg / Per Device)	$P_{TOT}$	$T_C = 25^\circ\text{C}$	590 / 1180	W	Fig. 3
Operating and Storage Temperature	$T_j, T_{stg}$		-55 to 175	$^\circ\text{C}$	

\* Per Device

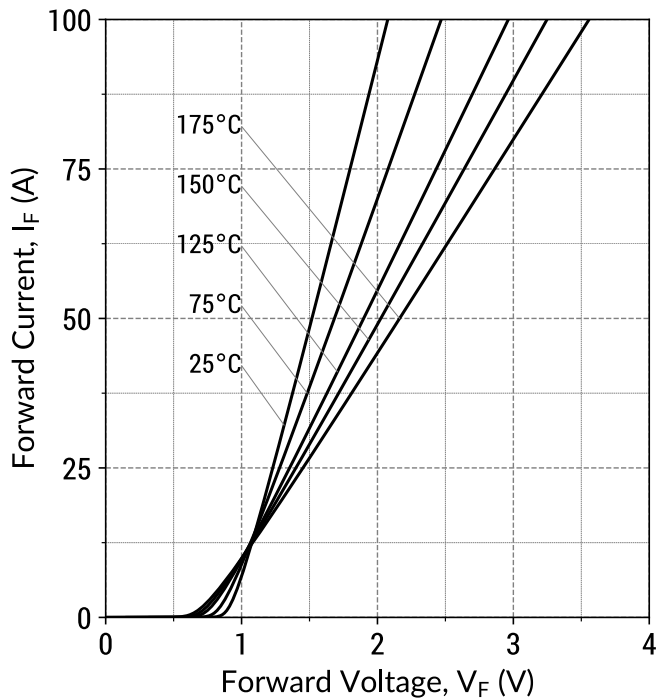
### Electrical Characteristics (Per Leg)

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Diode Forward Voltage	$V_F$	$I_F = 50 \text{ A}, T_j = 25^\circ\text{C}$		1.5	1.8	V	Fig. 1
		$I_F = 50 \text{ A}, T_j = 175^\circ\text{C}$		2.1			
Reverse Current	$I_R$	$V_R = 1700 \text{ V}, T_j = 25^\circ\text{C}$		2	10	$\mu\text{A}$	Fig. 2
		$V_R = 1700 \text{ V}, T_j = 175^\circ\text{C}$		42			
Total Capacitive Charge	$Q_C$	$I_F \leq I_{F,MAX}$ $di_F/dt = 200 \text{ A}/\mu\text{s}$	$V_R = 600 \text{ V}$		368	nC	Fig. 7
			$V_R = 1200 \text{ V}$		538		
Switching Time	$t_s$		$V_R = 600 \text{ V}$		< 10	ns	
			$V_R = 1200 \text{ V}$				
Total Capacitance	C	$V_R = 1 \text{ V}, f = 1\text{MHz}$		4701		pF	Fig. 6
		$V_R = 1200 \text{ V}, f = 1\text{MHz}$		259			

### Thermal/Package Characteristics

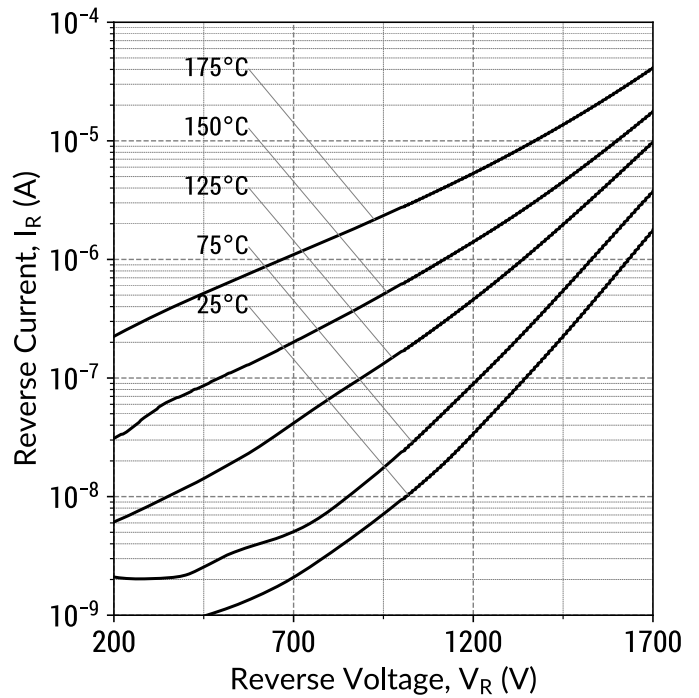
Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Thermal Resistance, Junction - Case (Per Leg)	$R_{thJC}$			0.25		$^\circ\text{C}/\text{W}$	Fig. 9
Weight	$W_T$			28.0		g	
Mounting Torque	$T_M$	Screws to Heatsink			1.5	Nm	
Terminal Connection Torque	$T_C$	M4 Screws			1.3	Nm	
Isolation Voltage(RMS)	$V_{iso}$	$t = 1\text{s} (50/60 \text{ Hz})$		3000		V	
		$t = 60\text{s} (50/60 \text{ Hz})$		2500			
Creepage Distance on Surface	$d_{ctt}$	Terminal to Terminal		10.5		mm	
	$d_{ctb}$	Terminal to Backside		8.5			
Striking Distance Through Air	$d_{stt}$	Terminal to Terminal		3.2		mm	
	$d_{stb}$	Terminal to Backside		6.8			

**Figure 1: Typical Forward Characteristics (Per Leg)**



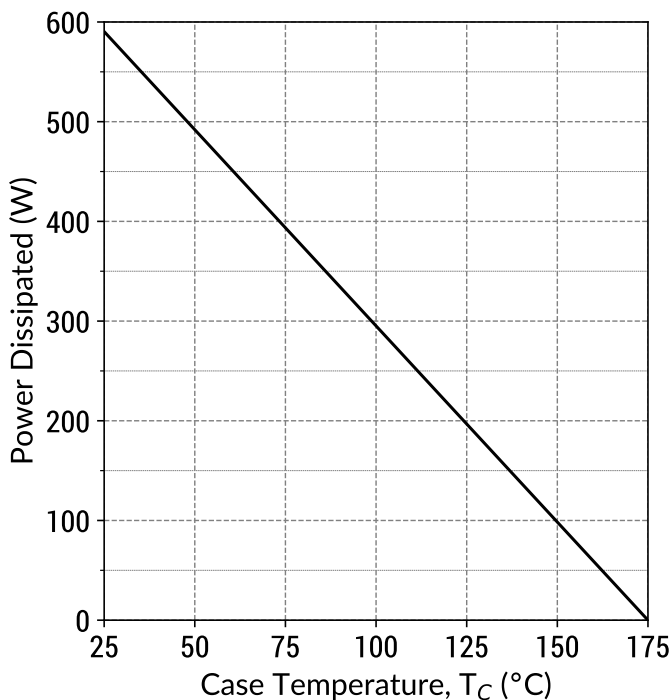
$I_F = f(V_F, T_j); t_P = 250 \mu s$

**Figure 2: Typical Reverse Characteristics (Per Leg)**



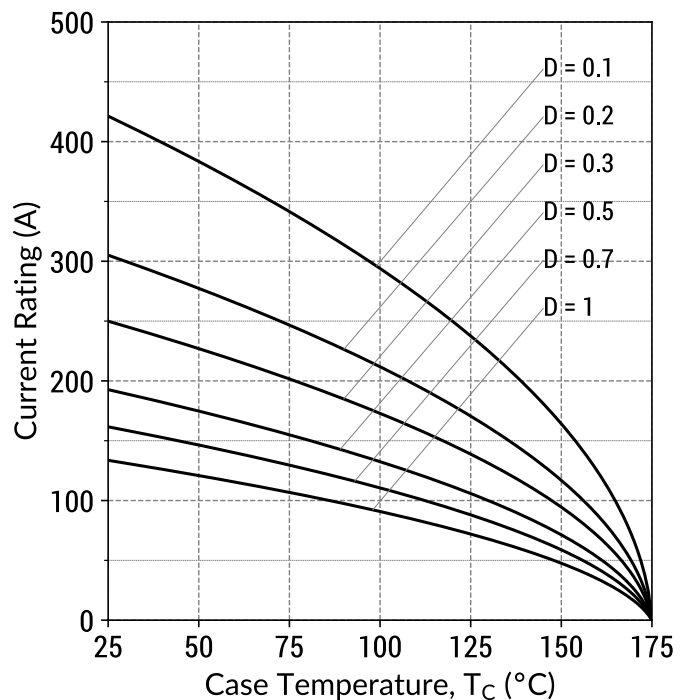
$I_R = f(V_R, T_j)$

**Figure 3: Power Derating Curves (Per Leg)**



$P_{TOT} = f(T_C); T_j = 175^\circ C$

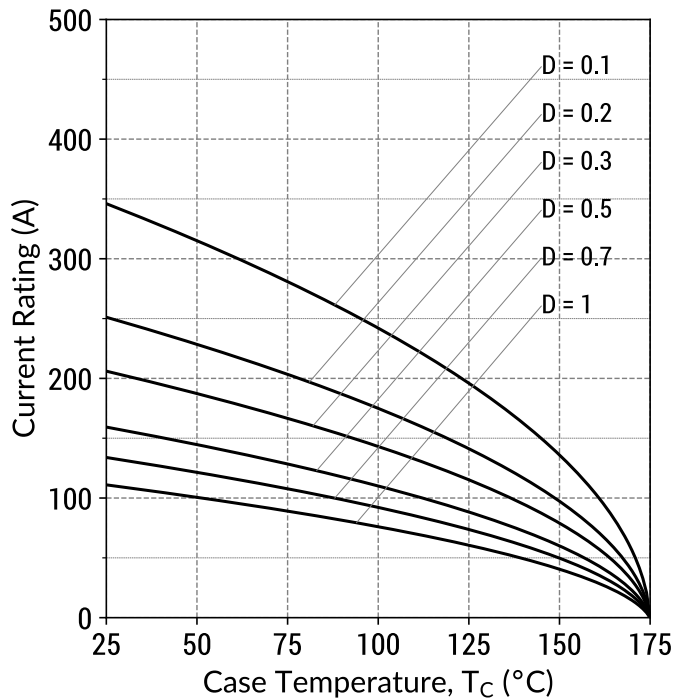
**Figure 4: Current Derating Curves (Typical  $V_F$ ) (Per Leg)**



$I_F = f(T_C); D = t_P/T; T_j \leq 175^\circ C; f_{sw} > 10kHz$

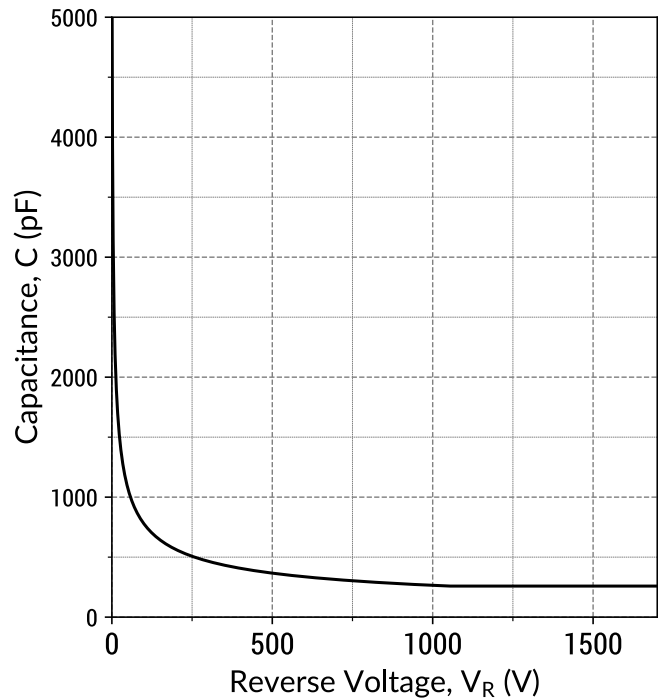


**Figure 5: Current Derating Curves (Maximum  $V_F$ ) (Per Leg)**



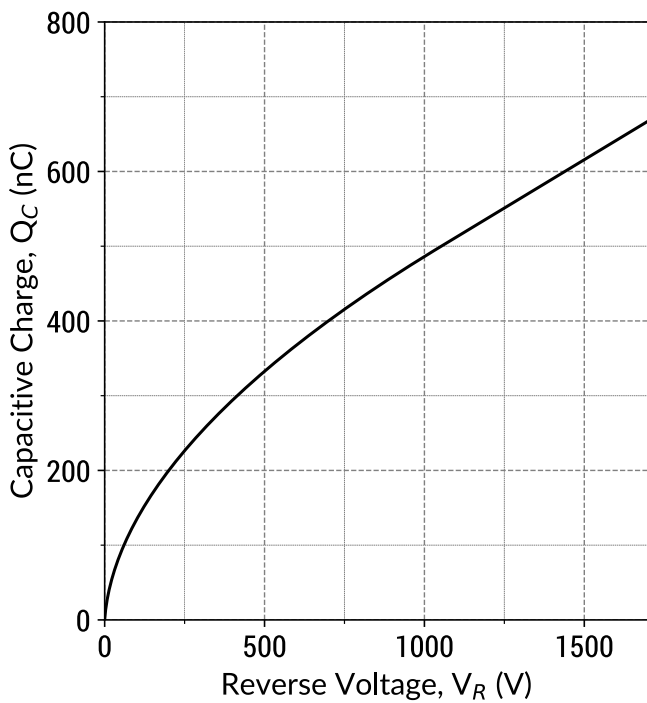
$I_F = f(T_C); D = t_P/T; T_J \leq 175^\circ\text{C}; f_{SW} > 10\text{kHz}$

**Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics (Per Leg)**



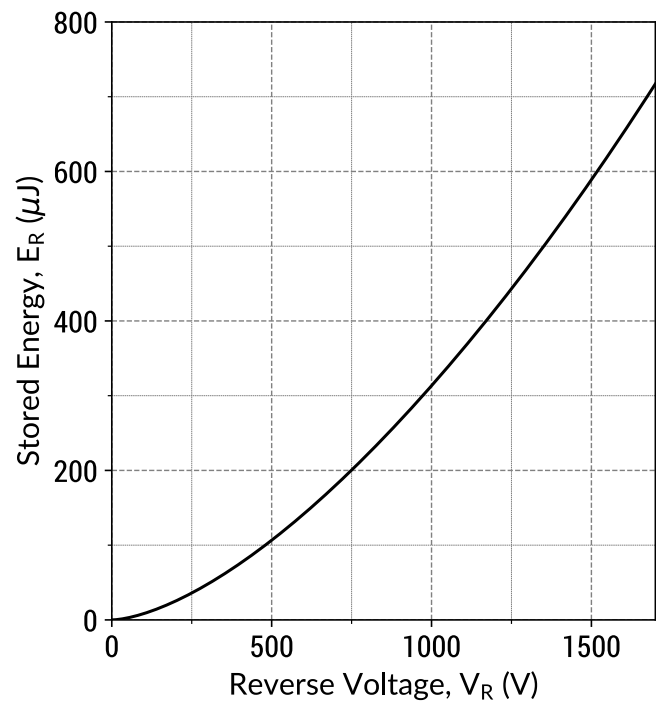
$C = f(V_R); f = 1\text{MHz}$

**Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics (Per Leg)**



$Q_C = f(V_R); f = 1\text{MHz}$

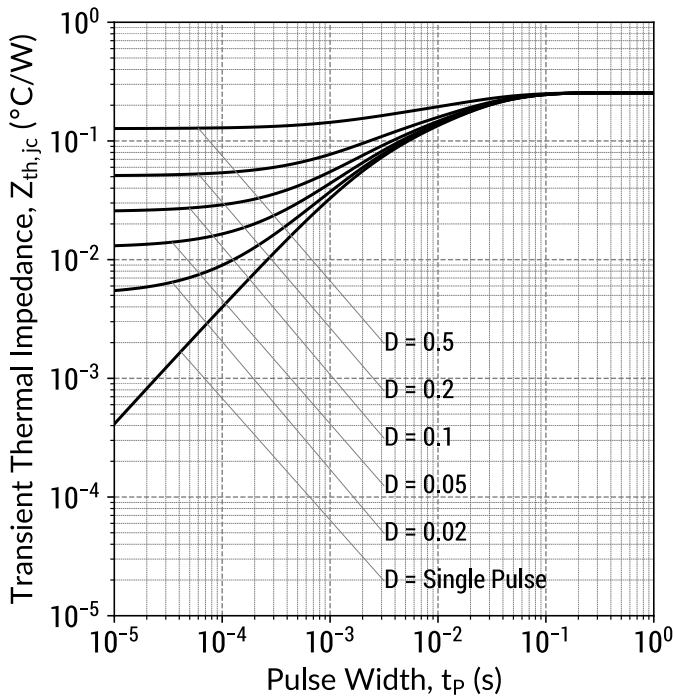
**Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics (Per Leg)**



$E_C = f(V_R); f = 1\text{MHz}$

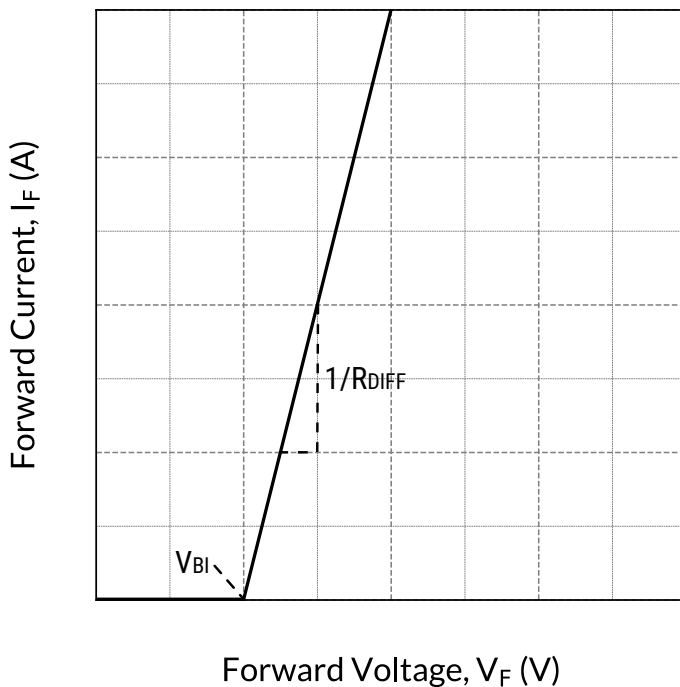


Figure 9: Transient Thermal Impedance (Per Leg)



$$Z_{th,jc} = f(t_p, D); D = t_p/T$$

Figure 10: Forward Curve Model (Per Leg)



$$I_F = f(V_F, T_j)$$

**Forward Curve Model Equation:**

$$I_F = (V_F - V_{BI})/R_{DIFF} \text{ (A)}$$

**Built-In Voltage ( $V_{BI}$ ):**

$$V_{BI}(T_j) = m \times T_j + n \text{ (V)}$$

$$m = -0.00128 \text{ (V/°C)}$$

$$n = 0.99 \text{ (V)}$$

**Differential Resistance ( $R_{DIFF}$ ):**

$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c \text{ (}\Omega\text{)}$$

$$a = 2.03e-07 \text{ (}\Omega\text{/°C}^2\text{)}$$

$$b = 7.11e-05 \text{ (}\Omega\text{/°C)}$$

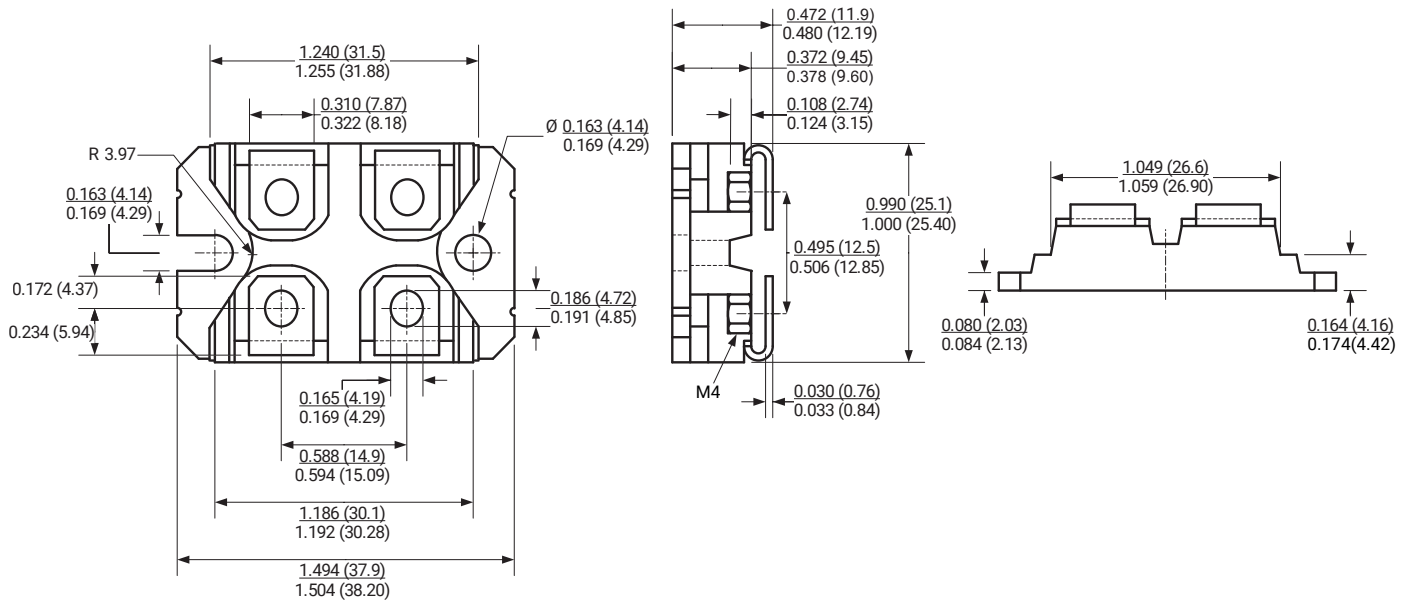
$$c = 0.0093 \text{ (}\Omega\text{)}$$

**Forward Power Loss Equation:**

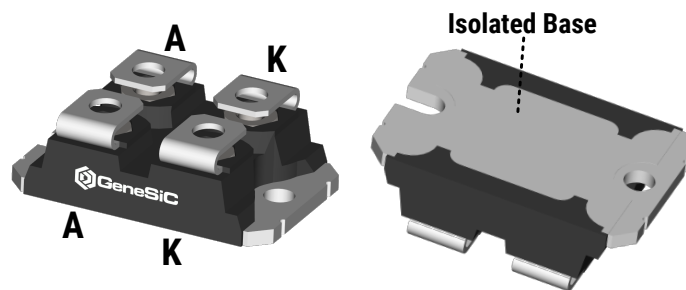
$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$

**Package Dimensions**

**SOT-227 Package Outline**



**Package View**



**NOTE**

1. CONTROLLED DEIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.



### RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

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REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.

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